Memory portfolio overview



Trusted supplier with the broadest portfolio of NOR Flash and specialty RAM memories

With over 40 years of experience, Infineon is the trusted supplier for the industry's broadest range of NOR Flash and specialty RAM memory solutions. We focus on the industrial, compute, communication, and automotive markets, and our longevity program offers 10+ years supply assurance for long-term platforms. Infineon advanced memory technologies deliver unique reliability for embedded application designs.

Memory type	Infineon product family	Interface	Volt.	Den.	Speed *1	Target application		
	Solutions for boot code and system data storage							
NOR Flash	SEMPER™ Secure Secured & safe	QSPI Octal (xSPI) HYPERBUS™	3.0V 1.8V	128Mb to 512Mb	Up to 400MB/s	Security enabled by hardware root-of-trust Networking, surveillance, smart factories, data centers; Secured boot and storage, secured end-to-end transitions		
	SEMPER™ Safety and high density	QSPI Octal (xSPI) HYPERBUS™	3.0V 1.8V	256Mb to 4Gb	Up to 400MB/s	Architected and designed for functional safety Robotics, industrial automation, motor drives, ADAS; Safety-critical operation, high speed, fast boot		
	SEMPER™ Nano Tiny footprint & low power	QSPI	1.8V	256Mb	Up to 52MB/s	Designed for smaller, faster, and smarter devices Hearables, wearables, smart sensors, portable medical; Compact, reliable, built-in ECC, low power		
	HYPERFLASH™ High performance	HYPERBUS™	3.0V 1.8V	128Mb to 512Mb	Up to 333MB/s	High throughput with HYPERBUS™ interface Industrial HMI, digital displays, clusters; Instant-on, image and graphics storage		
	Standard Serial Wide product range	QSPI Dual QSPI	3.0V 1.8V	64Mb to 1Gb	Up to 204MB/s	Wide range of industry-proven solutions Industrial, compute, communications and automotive; Reliable boot code and data storage		
	Standard Parallel Legacy NOR Flash	16/8-bit page mode	3.0V	64Mb to 2Gb	Down to 70ns / 15ns	Long-term support for legacy devices Mature products as in industrial and medical; Reliable boot code and data storage		

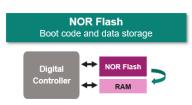
	Solutions for data logging and instant data capture								
F-RAM	EXCELON™ Ultra High perf & Instant write	SPI QSPI	1.8V 3.0V	2Mb to 16Mb	Up to 108MHz	"Unlimited" data logging, low-pin count, non-volatile Industrial automation, Server/RAID, smart meters; Data logging, critical data capture on power loss			
	EXCELON™ Auto AEC-Q100 & instant write	SPI QSPI	1.8V 3.3V	1Mb to 16Mb	Up to 108MHz	AEC-Q100 qualified, instant write, non-volatile Camera, sensor for ADAS, infotainment; Data logging, critical data capture on power loss			
	EXCELON™ LP Low power & small footprint	SPI	1.8V 3.3V	2Mb to 16Mb	Up to 50Mz	Ultra-low power, in-rush current control, non-volatile Portable medical devices, wearables, IoT devices; Data logging, instant data capture on power loss			
	Standard F-RAM High reliability & instant write	I2C, SPI, Parallel, x8, x16	3.3V 5.0V	4kb to 4Mb	Up to 40MHz / Down to 60ns	High-reliable, instant write, non-volatile Industrial, computing, networking; Data logging, instant data capture on power loss			
nvSRAM	nvSRAM High speed & dependable	Parallel, x8, x16	1.8V 3.0V 5.0V	256kb to 16Mb	Down to 25ns	High-speed, non-volatility with no battery backup RAID storage, industrial automation, gaming; Data logging, storage for critical data			
		I2C, SPI QSPI	1.8V 3.0V	64kb to 1Mb	Up to 108 MHz	Low pin count, non-volatility with no battery backup Industrial control and automation, smart metering; Data logging, storage for critical data			

^{*1:} Speeds in "MHz" refers to serial interfaces, the higher the number the faster the communication. Speeds in "ns" refer to parallel interfaces access times, the lower number the faster the communication.

	Expansion RAM for Data buffer and scratchpad							
Async SRAM	Async MoBL™ SRAM Ultra-low power & reliable	Parallel, x8, x16, x32	1.8V 3.0V 5.0V	1Mb to 64Mb	Down to 45 ns	Highly energy efficient, reliable memory Industrial automation, motor drives, insulin pumps; Data retention with battery backup, scratchpad		
	Async FAST SRAM High-speed & reliable	Parallel, x8, x16, x32	1.8V 3.0V 5.0V	256Kb to 32Mb	Down to 10ns	High-throughput, reliable memory Networking switches and routers, defense; High speed scratchpad, communication data buffer		
pSRAM	HYPERRAM™ 2.0 High speed & low pin count	HYPERBUS™ Octal (xSPI)	1.8V 3.0V	64Mb to 512Mb	Up to 400MB/s	High speed, low power, low pin count Wearables, IoT devices, HMI displays, machine vision; Expansion RAM for scratchpad and data buffer		
	HYPERRAM™ 3.0 High speed & low power	HYPERBUS™ x16	1.8V	256Mb	Up to 800MB/s	High throughput, low power Industrial, IoT devices, automotive V2X; Expansion RAM for scratchpad and data buffer		
Sync SRAM	Sync RAM High bandwidth & reliability	Parallel, x18, x36, x72	1.3V 1.8V 2.5V 3.3V	4Mb to 144Mb	Up to 2.1GT/s *2	Intensive processing support, random access Servers, image processing, defense, network cards; Expansion RAM for processing intensive applications		

^{*2: &}quot;GT/s" refers to Giga transactions per second

Use cases for Infineon NOR Flash and specialty RAM memories



Boot code

- 1. Code programmed during manufacturing
- 2. At power on, code copied to DRAM
- 3. Application runs from DRAM copy

Data storage

- Application parameters programmed during manufacturing
- 2. Controller reads and writes data while executing

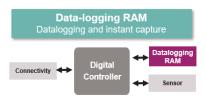
Expansion RAM Data buffer and scratchpad Data streaming Digital Controller Control algorithm

Data buffer

 RAM holds data temporarily to balance performance mismatches

Scratchpad

- Complex algorithms generate many intermediate results
- Intermediate results loaded in and out of scratch memory to enable fast compute



Instant data capture

- On power failure RAM instantly captures system state
- 2. On power recovery, operation re-starts safely

Instant data capture

- Data from sensors continuously saved in RAM for efficiency gains and preventative maintenance
- 2. System state saved continuously for diagnostics

Published by Infineon Technologies AG Am Campeon 1-15, 85579 Neubiberg Germany

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Public

Document number: B000-H0000-X-X-7600 Date: MM/2023

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